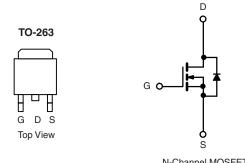
SQM40N15-38



Vishay Siliconix

Automotive N-Channel 150 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	150				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.038				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 6 V$	0.040				
I _D (A)	40				
Configuration	Single				



FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- · Package with Low Thermal Resistance
- AEC-Q101 Qualified^d
- 100 % $R_{\rm q}$ and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



N-Channel MOSFET				
ORDERING INFORMATION				
Package	TO-263			
Lead (Pb)-free and Halogen-free	SQM40N15-38-GE3			

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unless	otherwise noted	(k	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	150	V
Gate-Source Voltage		V _{GS}	± 20	v
Continuous Drain Current	T _C = 25 °C	I	40	
	T _C = 125 °C	I _D	23	
Continuous Source Current (Diode Conductio	n) ^a	I _S	100	А
Pulsed Drain Current ^b		I _{DM}	80	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	40	
Single Pulse Avalanche Energy	L = 0.1 MH	E _{AS}	80	mJ
Mauine Davies Dissis ationsh	T _C = 25 °C	PD	166	W
Maximum Power Dissipation ^b	T _C = 125 °C		55	vv
Operating Junction and Storage Temperature	Range	T _J , T _{stg}	- 55 to + 175	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	40	°C/W	
inction-to-Case (Drain)		R _{thJC}	0.9	0/10	

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static							I	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		150	-	-	v	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		3.0	3.5		
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = 150 V	-	-	1.0	μA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = 150 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50		
		$V_{GS} = 0 V$	V _{DS} = 150 V, T _J = 175 °C	-	-	250	1	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	50	-	-	Α	
		V _{GS} = 10 V	I _D = 15 A	-	0.027	0.038		
Drain Source On State Desistence?		V _{GS} = 10 V	I _D = 15 A, T _J = 125 °C	-	-	0.078	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 15 A, T _J = 175 °C	-	-	0.105		
		$V_{GS} = 6 V$	I _D = 10 A	-	0.030	0.040		
Forward Transconductanceb	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		-	40	-	S	
Dynamic ^b								
Input Capacitance	C _{iss}			-	2710	3390	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = 25 V, f = 1 MHz	-	310	390		
Reverse Transfer Capacitance	C _{rss}	1		-	130	165		
Total Gate Charge ^c	Qg			-	46	70	nC	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 75 \text{ V}, I_{D} = 85 \text{ A}$	-	20	-		
Gate-Drain Charge ^c	Q _{gd}	1		-	11	-		
Gate Resistance	Rg	f = 1 MHz		1	2	3	Ω	
Turn-On Delay Time ^c	t _{d(on)}	V_{DD} = 75 V, R _L = 0.88 Ω I _D ≅ 85 A, V _{GEN} = 10 V, R _g = 1 Ω		-	14	21	- ns	
Rise Time ^c	t _r			-	17	26		
Turn-Off Delay Time ^c	t _{d(off)}			-	24	36		
Fall Time ^c	t _f			-	9	14		
Source-Drain Diode Ratings and Char	acteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	80	А	
Forward Voltage	V _{SD}	١ _F	-	0.95	1.5	V		

Notes

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

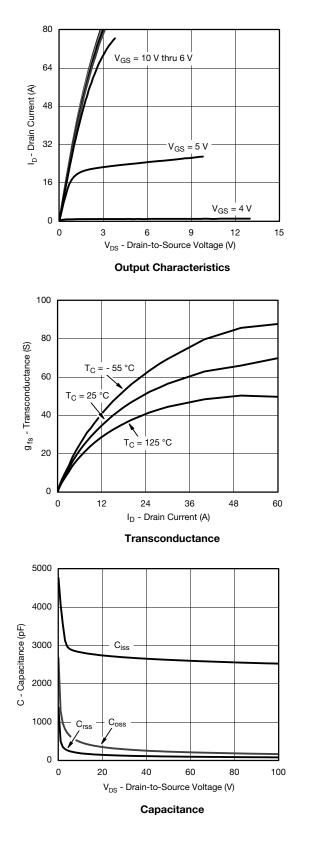
c. Independent of operating temperature.

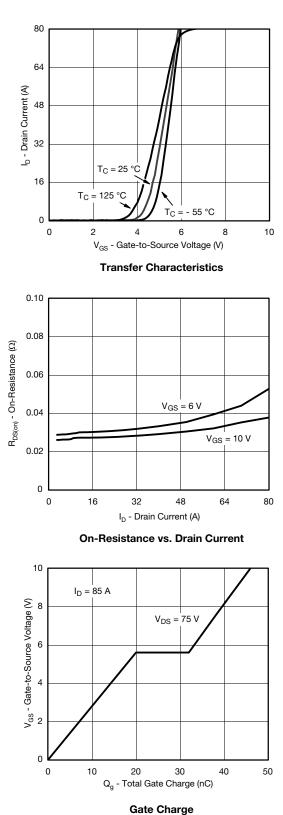
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)





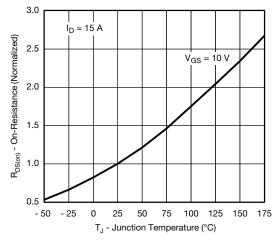
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Document Number: 65269

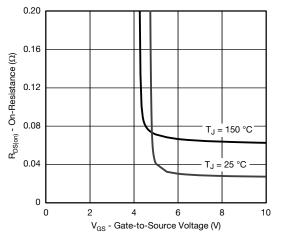
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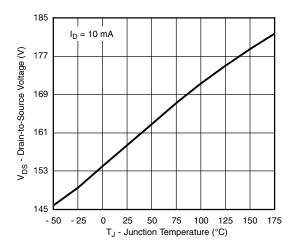
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



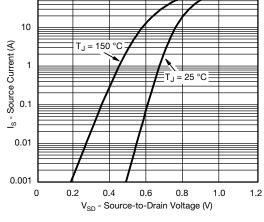




On-Resistance vs. Gate-to-Source Voltage

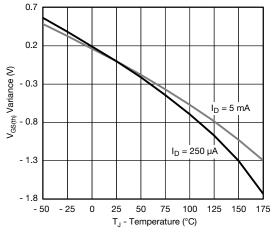


Drain Source Breakdown vs. Junction Temperature



100

Source Drain Diode Forward Voltage



Threshold Voltage

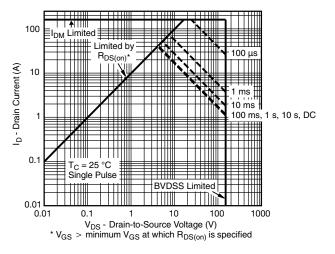
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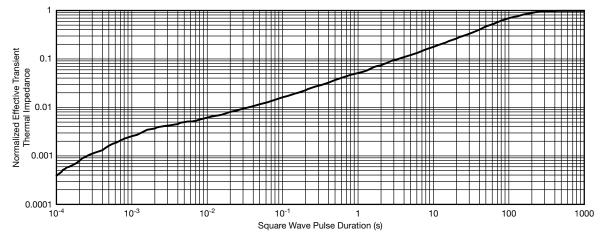
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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Safe Operating Area

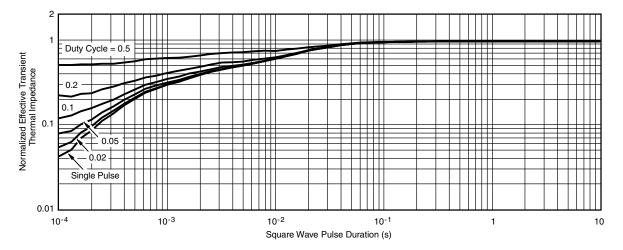


Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65269.

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TO-263 (D²PAK): 3-LEAD

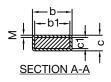








DETAIL A (ROTATED 90°)



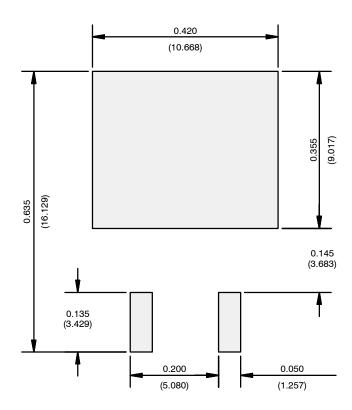
		INC	HES	MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
A		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	E	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
E2		0.355	0.375	9.017	9.525	
E3		0.072	0.078	1.829	1.981	
	е	0.100 BSC		2.54 BSC		
	К	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
L2		0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
L4 0.010 BSC		BSC	0.254 BSC			
М		-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843						

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 % of L1 can fall above seating plane by
- max. 8 mils.3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.
- 6. This feature is for thick lead.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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